

General Description

The MIC5283 high-performance linear regulator offers a very-wide input operating voltage range, up to 120V DC, and supplies an output current of up to 150mA.

Ideal for high input voltage applications such as industrial and telecom, the MIC5283 offers $\pm 3\%$ initial accuracy, extremely high-power supply rejection ratio (75dB at 10kHz) and an ultra-low quiescent current of 8 μ A. The MIC5283 is optimized for high-voltage line transients, making it ideal for harsh environment applications.

The MIC5283 is offered in both fixed output voltage (3.3V or 5.0V) and adjustable output voltage (1.22V to 5.5V) options.

The MIC5283 operates over a -40°C to $+125^{\circ}\text{C}$ temperature range and is available in lead-free, RoHS-compliant, ePad SOIC-8 and 3mm x 3mm MLF[®] packages.

Data sheet and support documentation are found on the Micrel website: www.micrel.com.

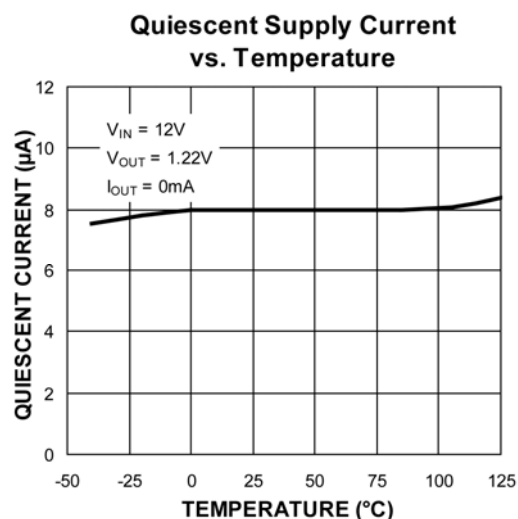
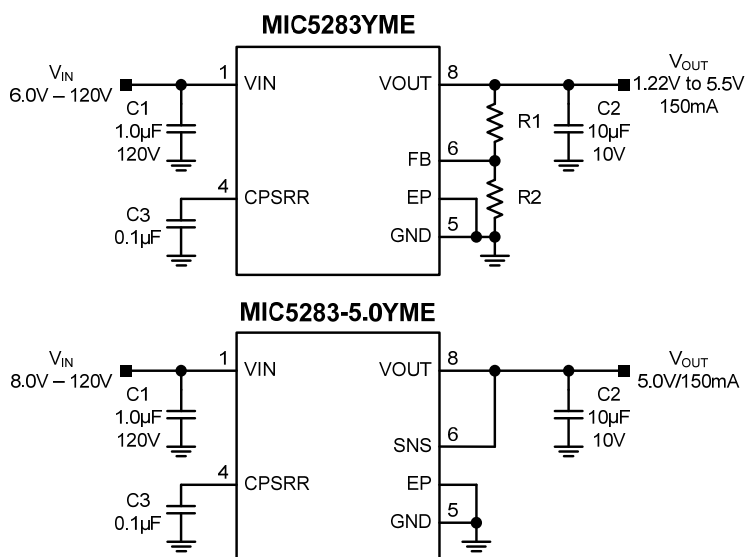
Features

- Wide input voltage range: 6V to 120V DC
- Ultra-low quiescent current: 8 μ A
- 150mA guaranteed output current
- Adjustable output from 1.22V to 5.5V
- Stable with ceramic capacitors
- Ultra-high PSRR (75dB at 10kHz)
- Ultra-high line rejection (load dump)
- High output accuracy:
 - $\pm 3\%$ initial accuracy
- Thermal-shutdown and current-limit protection
- Thermally-efficient, 8-pin ePad SOIC package
- Very low-profile 3mm x 3mm MLF[®] package

Applications

- Industrial applications
- Remote keyless entry power supply
- Telecom applications
- Off-line power supplies

Typical Applications

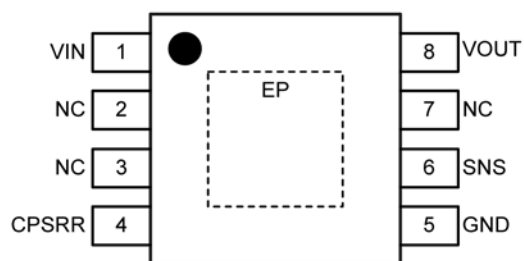


MLF and *MicroLeadFrame* are registered trademarks of Amkor Technology, Inc.

Ordering Information

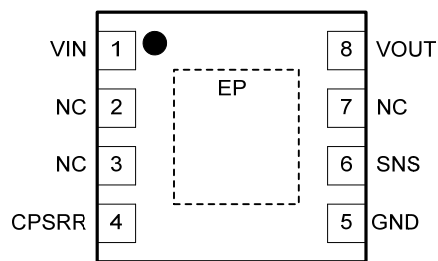
Part Number	Output Voltage	Top Mark	Temperature Range	Package	Lead Finish
MIC5283YME	Adjustable	5283YME	-40°C to +125°C	8-Pin ePad SOIC	Pb-Free
MIC5283-3.3YME	3.3V	5283-33YME	-40°C to +125°C	8-Pin ePad SOIC	Pb-Free
MIC5283-5.0YME	5.0V	5283-50YME	-40°C to +125°C	8-Pin ePad SOIC	Pb-Free
MIC5283YML	Adjustable	A83	-40°C to +125°C	3mmx3mm MLF [®] -8L	Pb-Free
MIC5283-3.3YML	3.3V	8S3	-40°C to +125°C	3mmx3mm MLF [®] -8L	Pb-Free
MIC5283-5.0YML	5.0V	583	-40°C to +125°C	3mmx3mm MLF [®] -8L	Pb-Free

Pin Configuration



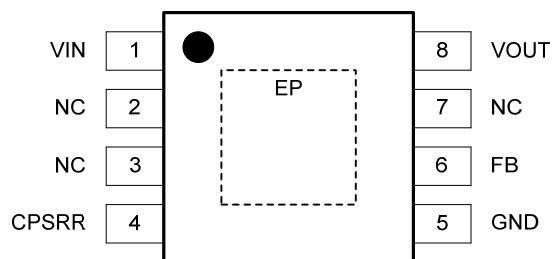
**8-Pin ePAD SOIC
MIC5283-x.xYME
Fixed Voltage Output**

(TOP VIEW)



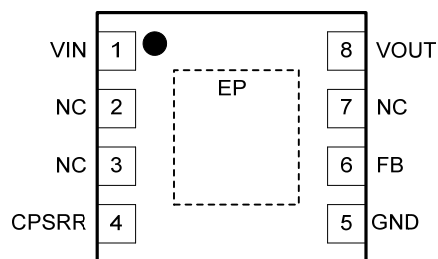
**3mm x 3mm MLF[®]-8L
MIC5283-x.xYML
Fixed Voltage Output**

(TOP VIEW)



**8-Pin ePAD SOIC
MIC5283YME
Adjustable Voltage Output**

(TOP VIEW)



**3mm x 3mm MLF[®]-8L
MIC5283YML
Adjustable Voltage Output**

(TOP VIEW)

Pin Description

Pin Number		Name	Function
Adjustable Output	Fixed Output		
1	1	VIN	Supply Voltage Input. Connect 1 μ F capacitor from VIN to GND.
2, 3, 7	2, 3, 7	NC	Not internally connected. Connect NC to GND or leave unconnected.
4	4	CPSRR	Bypass Capacitor Connection. Connect 0.1 μ F capacitor from CPSRR to GND.
5	5	GND	Ground.
6	—	FB	Feedback Connection. For external resistor divider to set V _{OUT} .
—	6	SNS	Sense input. Connect SNS to V _{OUT} .
8	8	VOUT	Regulator Output. Connect 10 μ F capacitor from V _{OUT} to GND.
EP	EP	EP	Exposed Pad (ePad) for Thermal Dissipation. Connect EP to GND.

Absolute Maximum Ratings⁽¹⁾

V_{IN} to GND.....	-0.3V to +125V
V_{CPSRR} to GND.....	-0.3 to +14V
V_{FB} , V_{SNS} , V_{OUT} to GND	-0.3V to +6V
Lead Temperature (soldering, 10s).....	+260°C
Junction Temperature	-40°C ≤ T_J ≤ +125°C
Storage Temperature	-65°C ≤ T_A ≤ +150°C
ESD Ratings⁽⁴⁾	
HBM.....	2kV
MM.....	200V

Electrical Characteristics⁽⁵⁾

$V_{IN} = 12V$, $C_{IN} = 1.0\mu F$, $C_{PSRR} = 0.1\mu F$, $C_{OUT} = 10\mu F$, $V_{OUT} = 5.0V$ or $3.3V$, $I_{OUT} = 100\mu A$, $T_A = 25^\circ C$, **bold** values indicate $-40^\circ C \leq T_J \leq +125^\circ C$, unless noted.

Parameter	Condition	Min.	Typ.	Max.	Units
Power Supply Input					
Input Voltage Range		6		120	V
Quiescent Supply Current	$I_{OUT} = 0$		8	14	μA
Output Voltage					
Output Voltage Accuracy	Variation from nominal V_{OUT} $100\mu A \leq I_{OUT} \leq 150mA$	-3		+3	%
		-5		+5	%
Line Regulation ⁽⁶⁾	$10V \leq V_{IN} \leq 120V$	-0.5	0.04	+0.5	%/V
Feedback Input (Adjustable)					
FB Voltage	$100\mu A \leq I_{OUT} \leq 150mA$	1.183	1.220	1.256	V
		1.159	1.220	1.281	
FB Current	$V_{FB} = 1.22V$		3.2		nA
Current Limit					
Current Limit	$V_{OUT} = 0V$	180	300	500	mA
Ripple Rejection					
Power Supply Rejection Ratio	$I_{OUT} = 50mA$	$100Hz \leq f \leq 1kHz$		70	dB
		$1kHz < f \leq 30kHz$		75	dB
		$30kHz < f \leq 100kHz$		65	dB
Power Dropout Voltage					
Dropout Voltage	$I_{OUT} = 150mA$		1.8	2.8	V
Thermal Protection					
Thermal-Shutdown Temperature	T_J rising		155		°C
Thermal-Shutdown Hysteresis			15		°C

Notes:

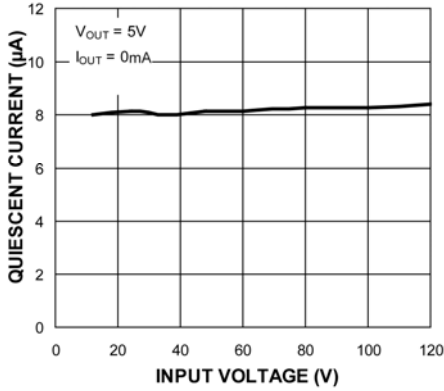
- Exceeding an absolute maximum rating may damage the device.
- The device is not guaranteed to function outside its operating rating.
- The maximum allowable power dissipation at any T_A (ambient temperature) is $P_{D(max)} = (T_{J(max)} - T_A) / \theta_{JA}$. Exceeding the maximum allowable power dissipation results in excessive die temperature, and causes the regulator to enter thermal shutdown.
- Devices are ESD sensitive; use proper handling precautions.
- Specifications are for packaged products only.
- Line regulation is a percentage of V_{OUT} .

Operating Ratings⁽²⁾

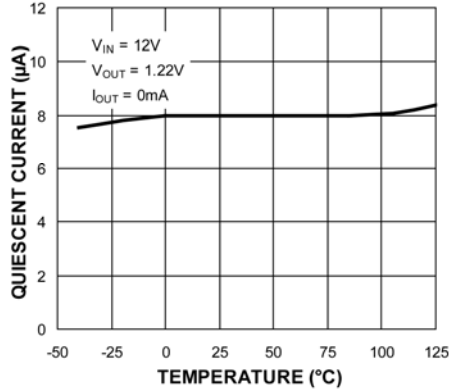
V_{IN}	+6V to +120V
V_{OUT} Adjust Range	+1.22V to +5.5V
Junction Temperature	-40°C ≤ T_J ≤ +125°C
Power Dissipation (P_D).....	Internally Limited ⁽³⁾
Junction Thermal Resistance (θ_{JA})	
8-pin ePad SOIC	41°C/W
3mm x 3mm MLF [®] -8.....	60°C/W

Typical Characteristics

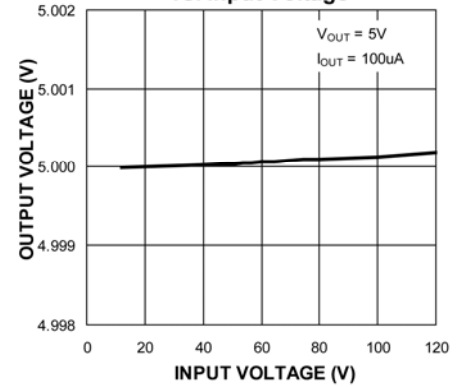
Quiescent Supply Current vs. Input Voltage



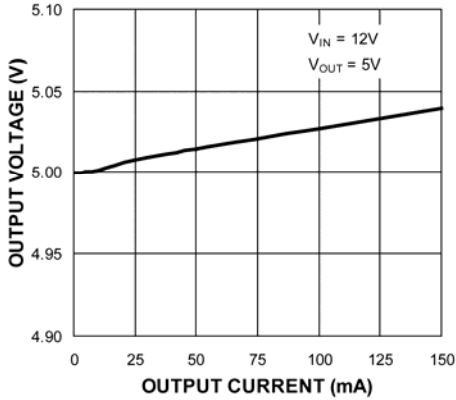
Quiescent Supply Current vs. Temperature



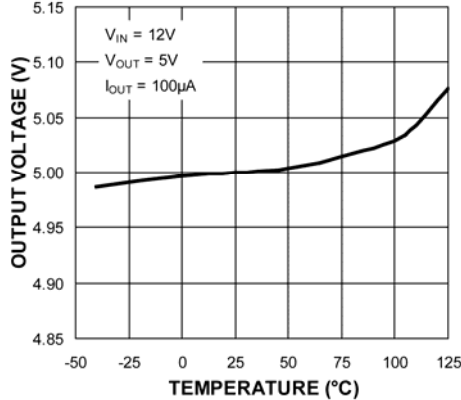
Output Voltage vs. Input Voltage



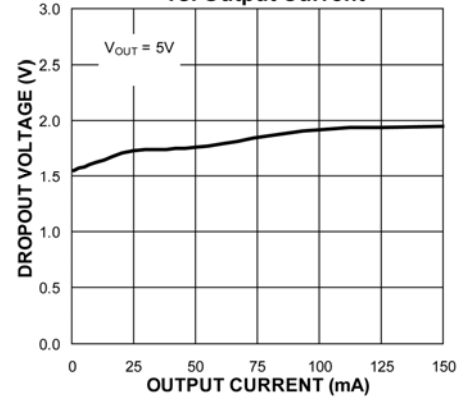
Output Voltage vs. Output Current



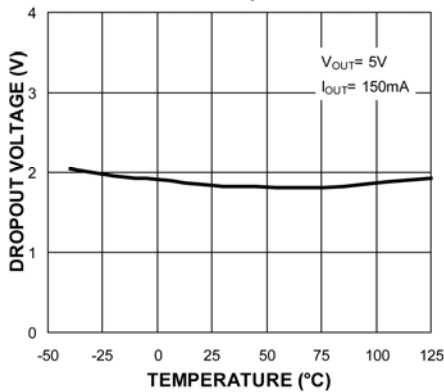
Output Voltage vs. Temperature



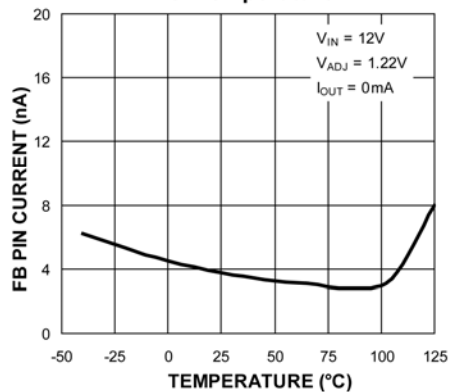
Dropout Voltage vs. Output Current



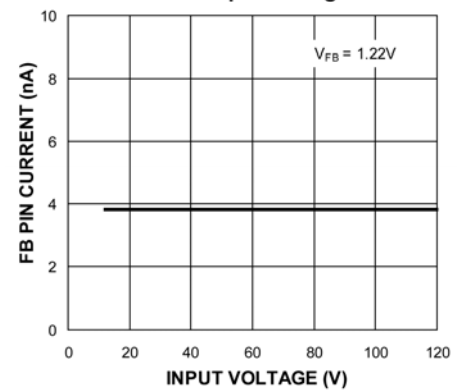
Dropout Voltage vs. Temperature



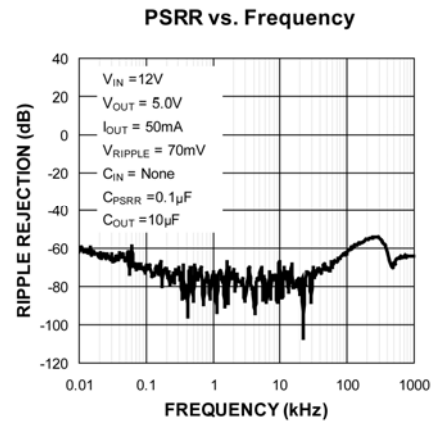
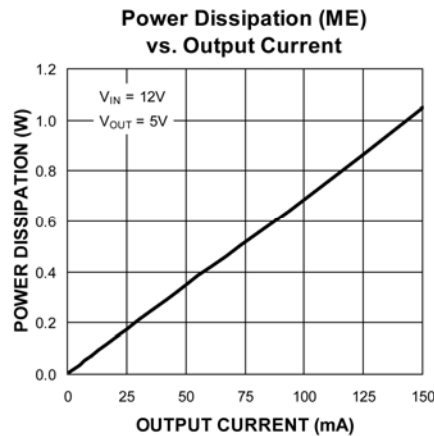
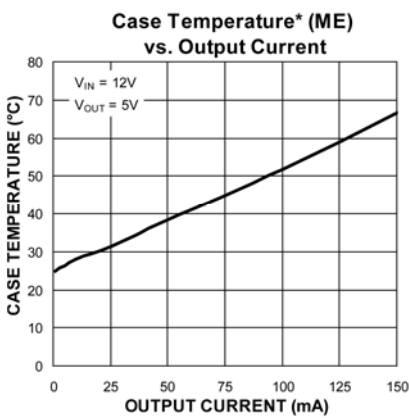
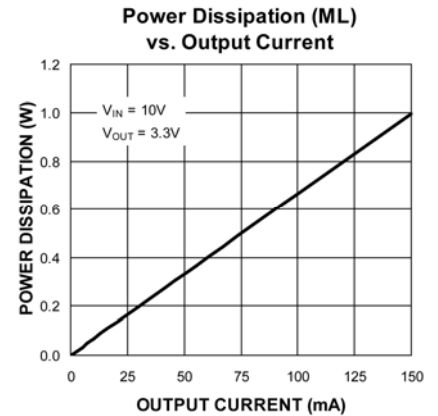
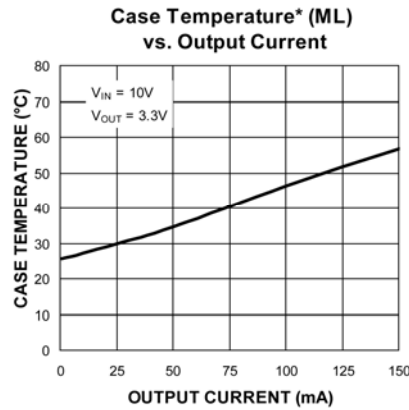
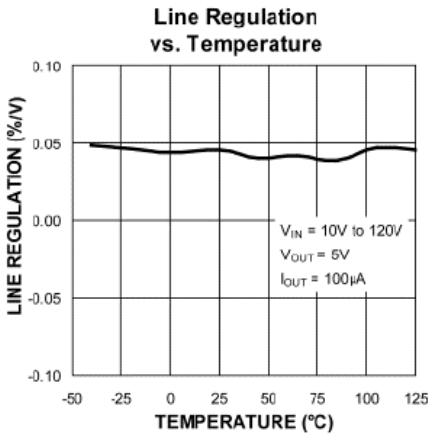
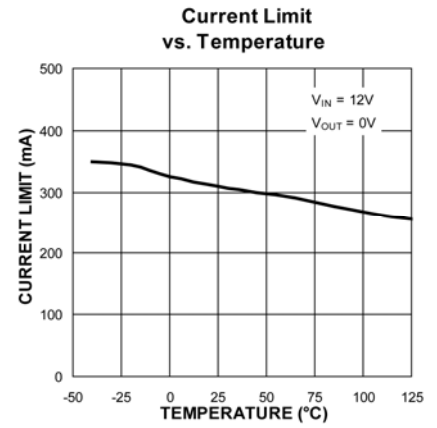
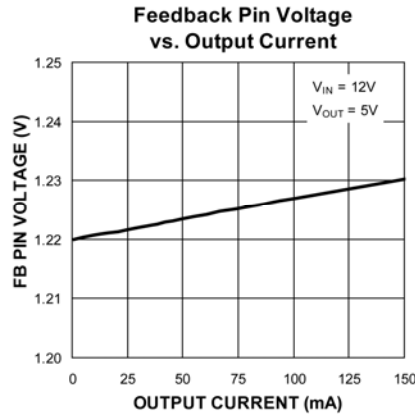
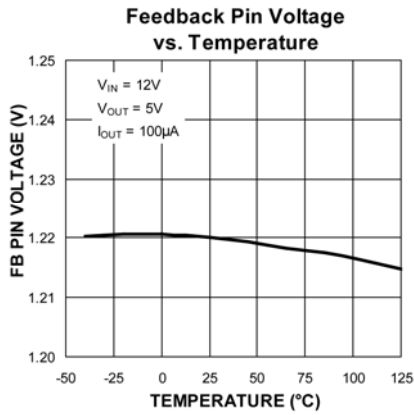
Feedback Pin Current vs. Temperature



Feedback Pin Current vs. Input Voltage



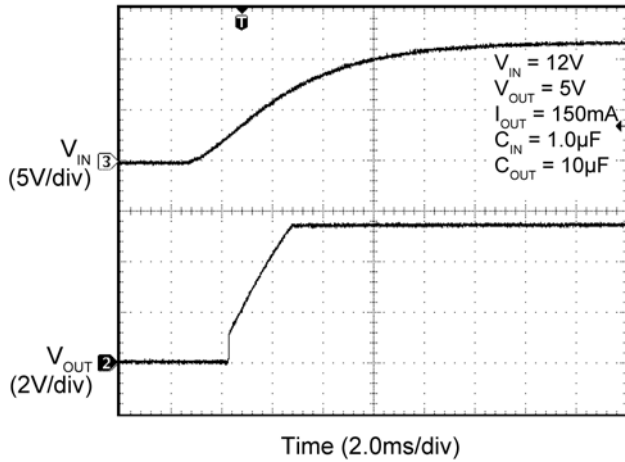
Typical Characteristics (Continued)



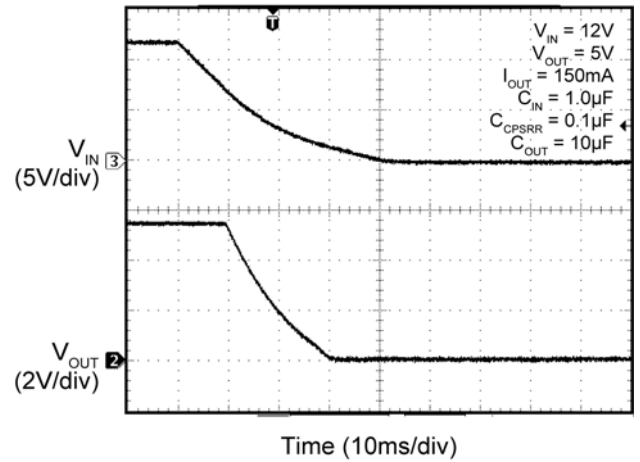
Case Temperature*: The temperature measurement was taken at the hottest point on the MIC5283 case mounted on a 2.25 square inch PCB at an ambient temperature of 25°C; see “Thermal Measurement” section. Actual results will depend upon the size of the PCB, ambient temperature and proximity to other heat emitting components.

Functional Characteristics

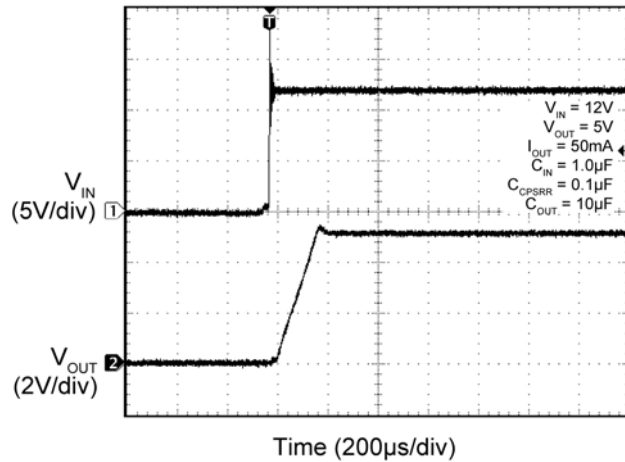
Soft Turn-On into Full Load



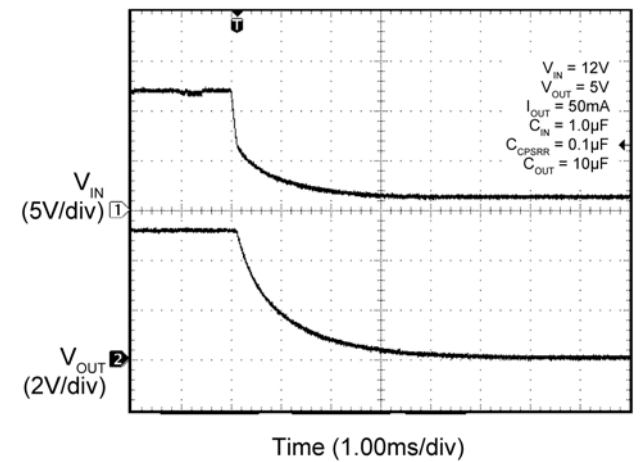
Soft Turn-Off



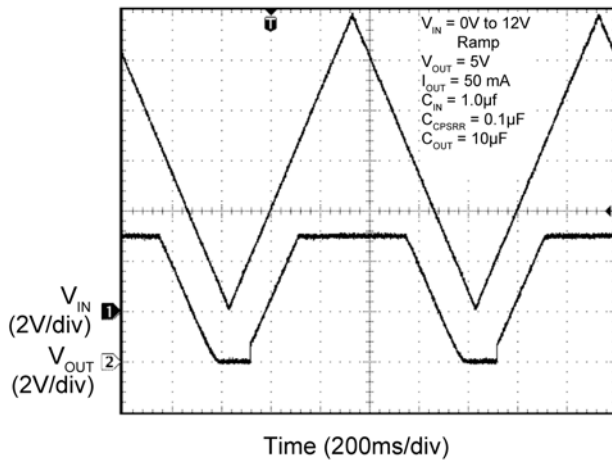
Fast Turn-On



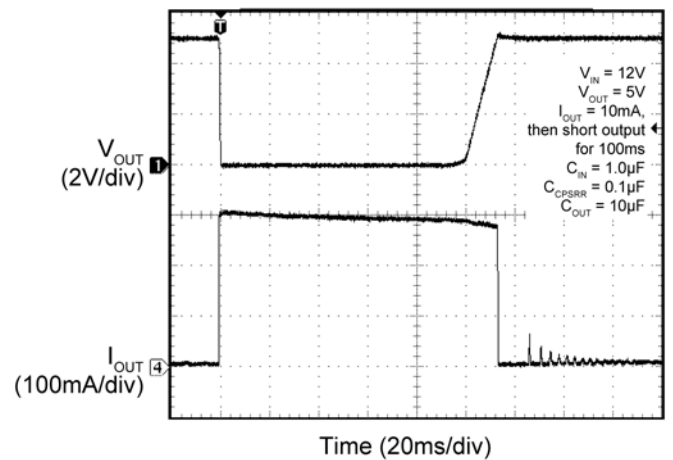
Fast Turn-Off



V_{IN} ULVO Threshold

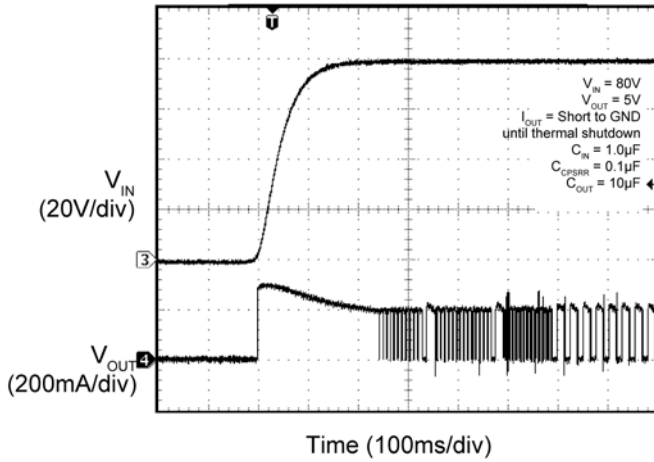


Current Limit

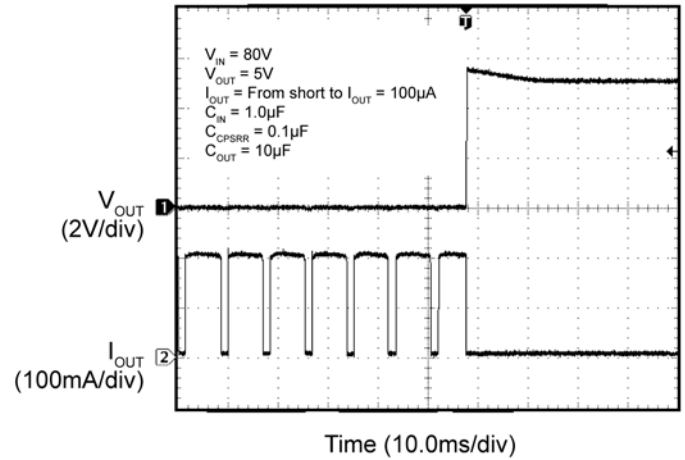


Functional Characteristics (Continued)

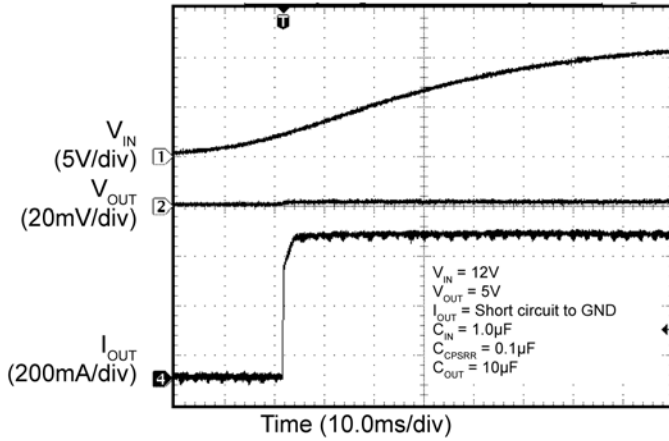
Thermal Shutdown Response



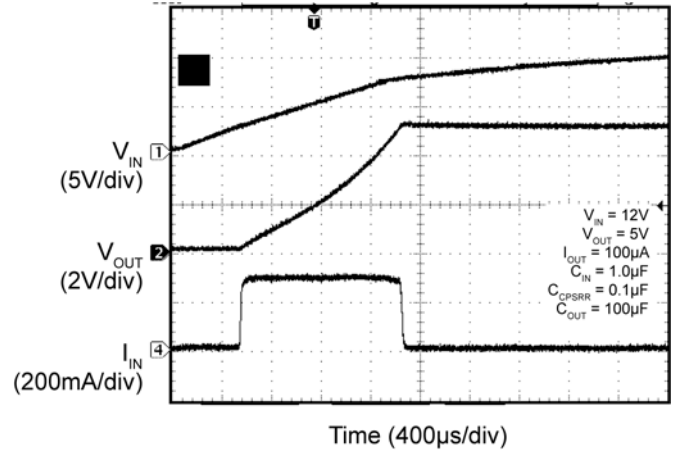
V_{OUT} Recovery from Thermal Shutdown



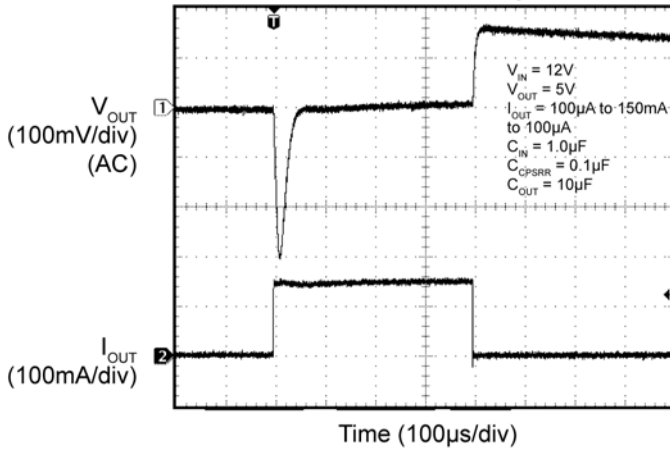
Turn-On into Short Circuit



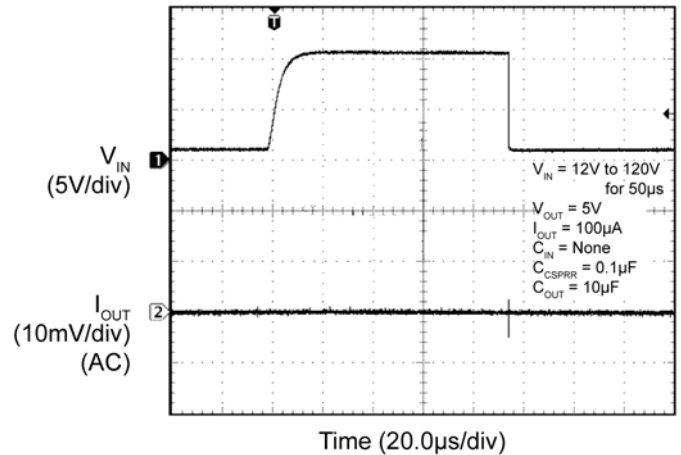
Inrush Current Response



Load Transient Response



Line Transient Response



Detailed Description

The MIC5283 voltage regulator accepts a 6V to 120V input voltage and has an ultra-low 8 μ A typical quiescent current while offering an excellent line transient response and PSRR. These features make it ideal for harsh, noisy environments. All options offer 150mA of output current. The MIC5283YML and MIC5283YME offer an adjustable output voltage from 1.22V to 5.5V. The MIC5283-3.3YML and MIC5283-3.3YME offer fixed 3.3V outputs and the MIC5283-5.0YML and MIC5283-5.0YME offer fixed 5.0V outputs. The YME packaged devices feature a heat slug to more effectively remove heat from the die.

Applications Information

Thermal Protection

The MIC5283 has internal thermal shutdown to protect it from excessive heating of the die. When the junction temperature exceeds approximately +155°C, the output is disabled and the device begins to cool down. The device turns back on when the junction temperature cools by 15°C. This will result in a cycled output during continuous thermal-overload conditions.

Current Limit

The MIC5283 features output current-limit protection. The output sustains a continuous short circuit to GND without damage to the device, but thermal shutdown often results. The typical value for the current limit of the MIC5283 is 300mA.

Input Capacitor

Connect a 1.0 μ F capacitor from VIN to GND. Micrel recommends the C5750X7R2E105M, 1.0 μ F, 250V capacitor made by TDK. When using a different capacitor, assure that the voltage rating of the capacitor has adequate headroom to withstand any potential transient.

CPSRR Capacitor

To maintain high power supply rejection, connect a 0.1 μ F capacitor from CPSRR to GND. The voltage rating of the capacitor must be at least 14V.

Output Capacitor

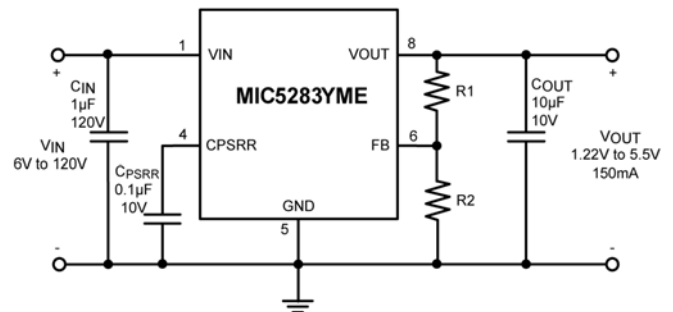
Connect a 10 μ F capacitor from VOUT to GND. Assure that the voltage rating of the capacitor exceeds the designed output voltage of the MIC5283.

Output Voltage Setting

For the MIC5283YML and MIC5283YME, V_{OUT} is programmable from 1.22V to 5.5V using an external resistive divider. V_{OUT} is set using the following equation:

$$V_{OUT} = V_{REF} \times \left(\frac{R1}{R2} + 1 \right)$$

where V_{REF} = 1.22V, and R1 and R2 form the feedback voltage divider from V_{OUT} to ground.

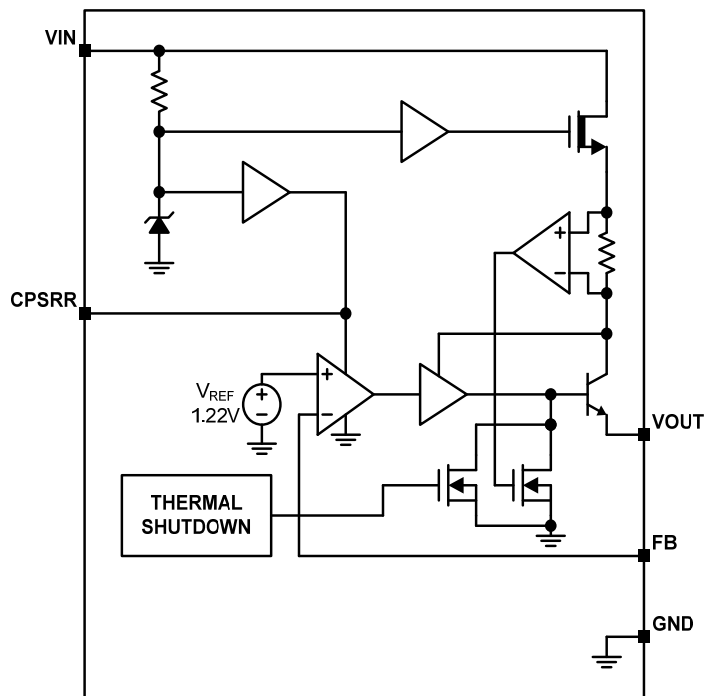


Thermal Measurements

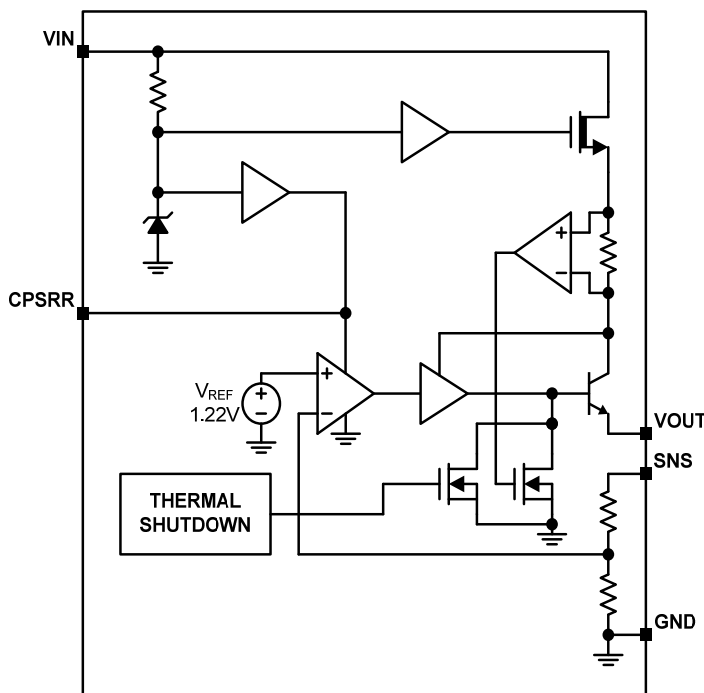
It is always prudent to measure an IC's case temperature to make sure that it is within operating limits, but it is easy to get erroneous results. The standard thermocouple that comes with many voltage meters uses a large wire gauge that behaves like a heat-sink, resulting in artificially low case temperature measurements. Use a thermocouple of 36-gauge wire or smaller, such as the Omega (5SC-TT-K-36-36), to minimize the heat-sinking effect. Also, apply a thermal compound to maximize heat transfer between the IC and the thermocouple.

An infrared thermometer is a recommended alternative. The IR thermometer from Optris has a 1mm spot size, ideal for monitoring small surface mount packages. Also, the optional stand makes it easy to keep the beam on the IC for long periods of time.

Functional Diagram

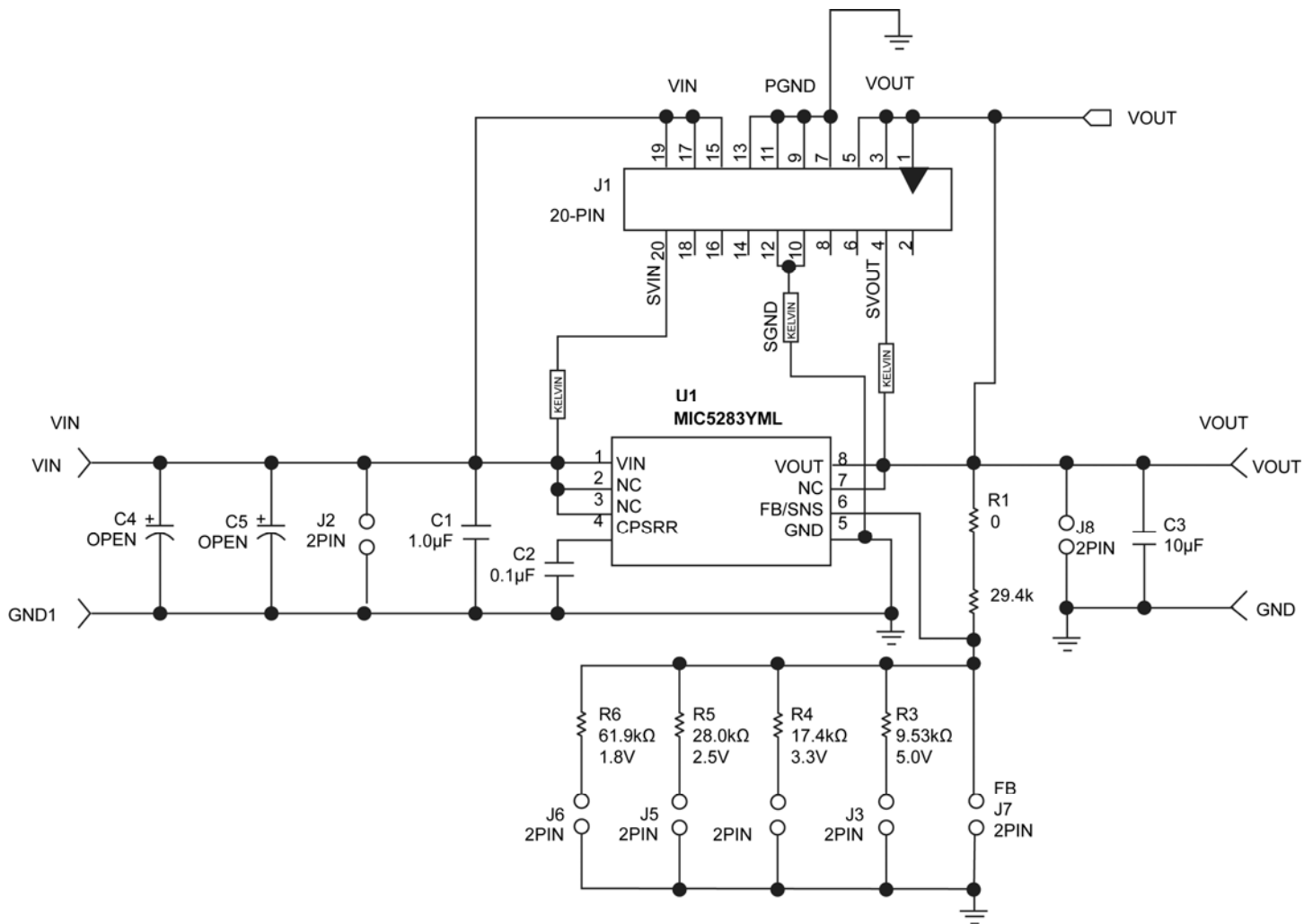


MIC5283 Adjustable Version



MIC5283 Fixed Version

MIC5283 Evaluation Board Schematic



MIC5283 Evaluation Board Schematic

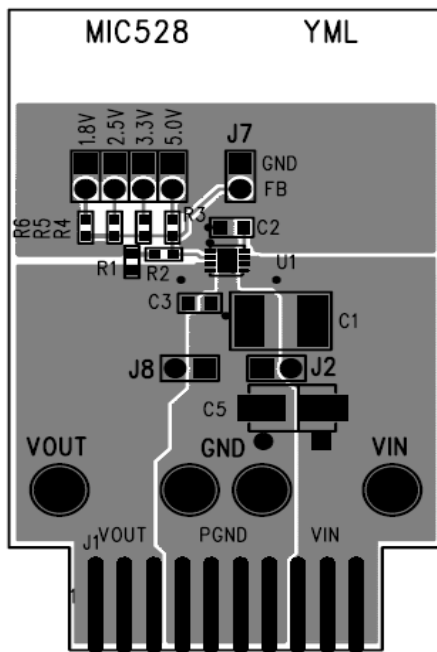
Bill of Materials

Item	Part Number	Manufacturer	Description	Qty.
C1	C5750X7R2E105M	TDK ⁽¹⁾	1.0μF, 250V, 20%, X7R capacitor (2220)	1
C2	08053C104KAT2A	AVX ⁽²⁾	0.1μF 25V 20%, X7R capacitor (0805)	1
C3	0805ZD106KAT2A	AVX ⁽²⁾	10μF, 10V, 20%, X5R, capacitor (0805)	1
R1	CRCW06030000F	Vishay/Dale ⁽³⁾	0Ω, 1% resistor, 0603	1
R2	CRCW06032942F	Vishay/Dale ⁽³⁾	29.4kΩ, 1% resistor, 0603	1
R3	CRCW06039531F	Vishay ⁽³⁾	9.53kΩ Film Resistor, Size 0603, 1%	1
R4	CRCW06031742F	Vishay ⁽³⁾	17.4kΩ Film Resistor, Size 0603, 1%	1
R5	CRCW06032802F	Vishay ⁽³⁾	28.0kΩ Film Resistor, Size 0603, 1%	1
R6	CRCW06036192F	Vishay ⁽³⁾	61.9kΩ Film Resistor, Size 0603, 1%	1
U1	MIC5283YML	Micrel⁽⁴⁾	120V_{IN}, 150mA, Ultra-Low I_Q, High-PSRR Linear Regulator	1

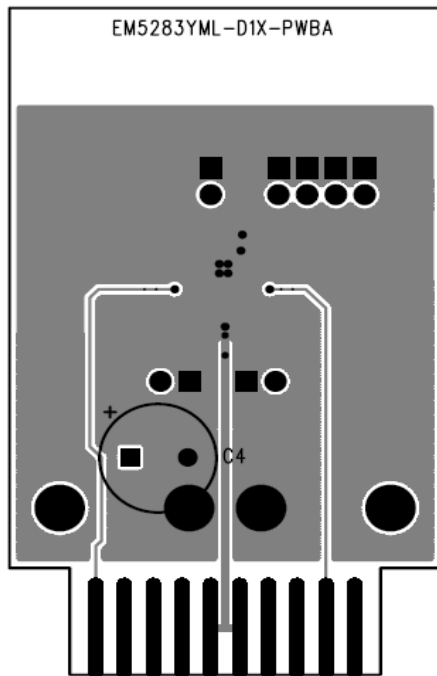
Notes:

1. TDK: www.tdk.com.
2. AVX.: www.avx.com.
3. Vishay Tel: www.vishay.com.
4. Micrel, Inc.: www.micrel.com.

PCB Evaluation Board Layout

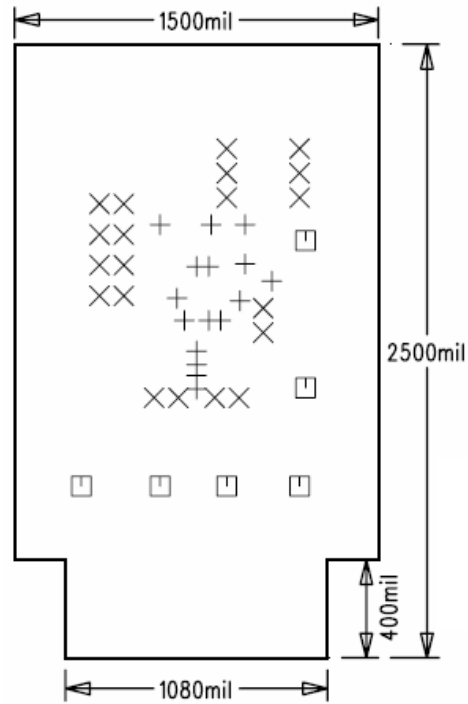


Top Layer



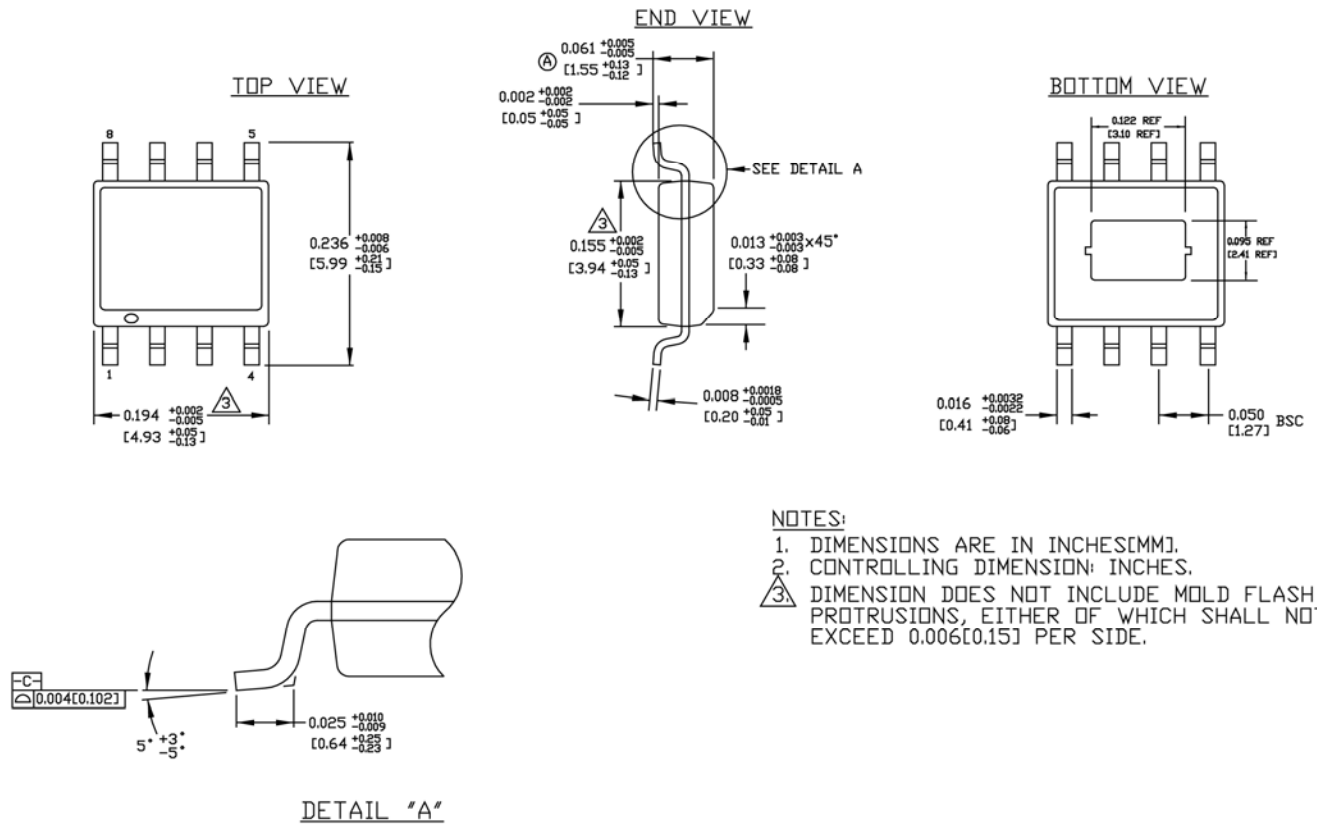
Bottom Layer

PCB Evaluation Board Layout (Continued)



EV Board Dimensions

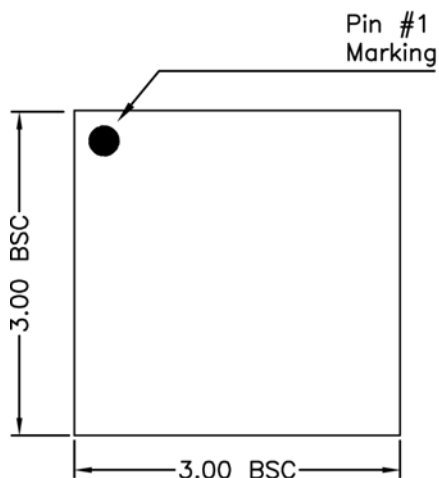
Package Information



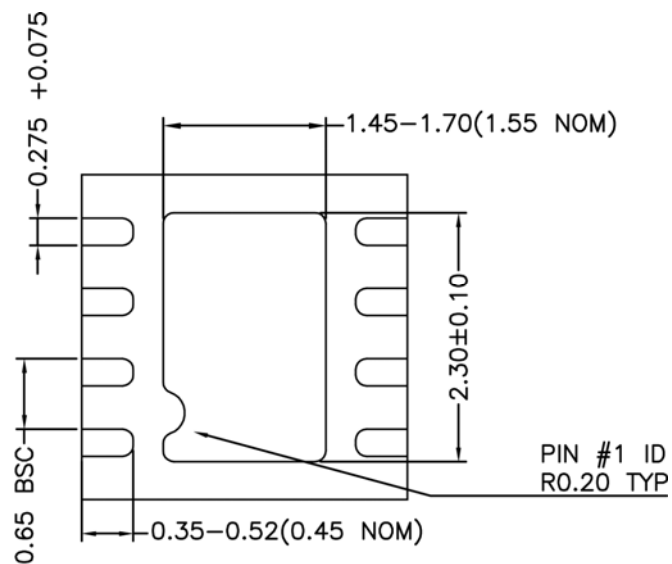
- NOTES:
1. DIMENSIONS ARE IN INCHES[MM].
 2. CONTROLLING DIMENSION: INCHES.
 3. DIMENSION DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS, EITHER OF WHICH SHALL NOT EXCEED 0.006[0.15] PER SIDE.

8-Pin Exposed Pad SOIC (ME)

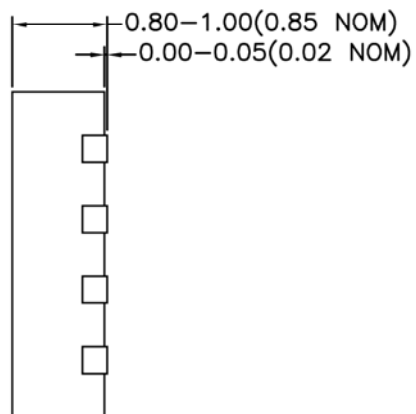
Package Information (Continued)



TOP VIEW



BOTTOM VIEW



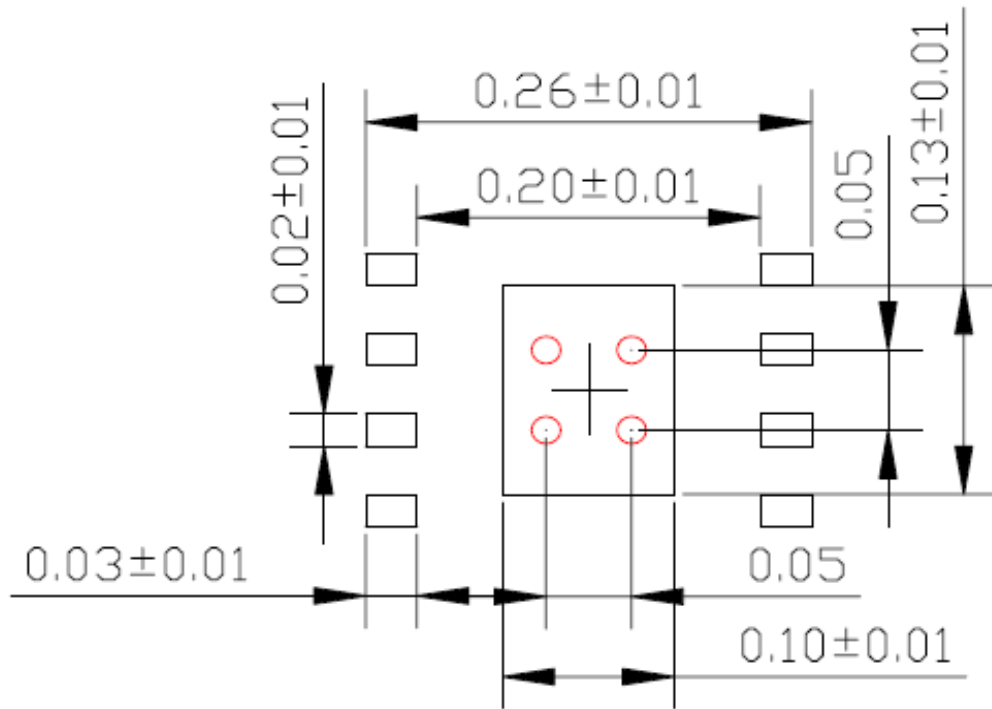
SIDE VIEW

8-Pin 3mmx3mm MLF[®] (ML)

Recommended Land Pattern

Recommended Land Pattern for EPAD SOIC 8 Lead

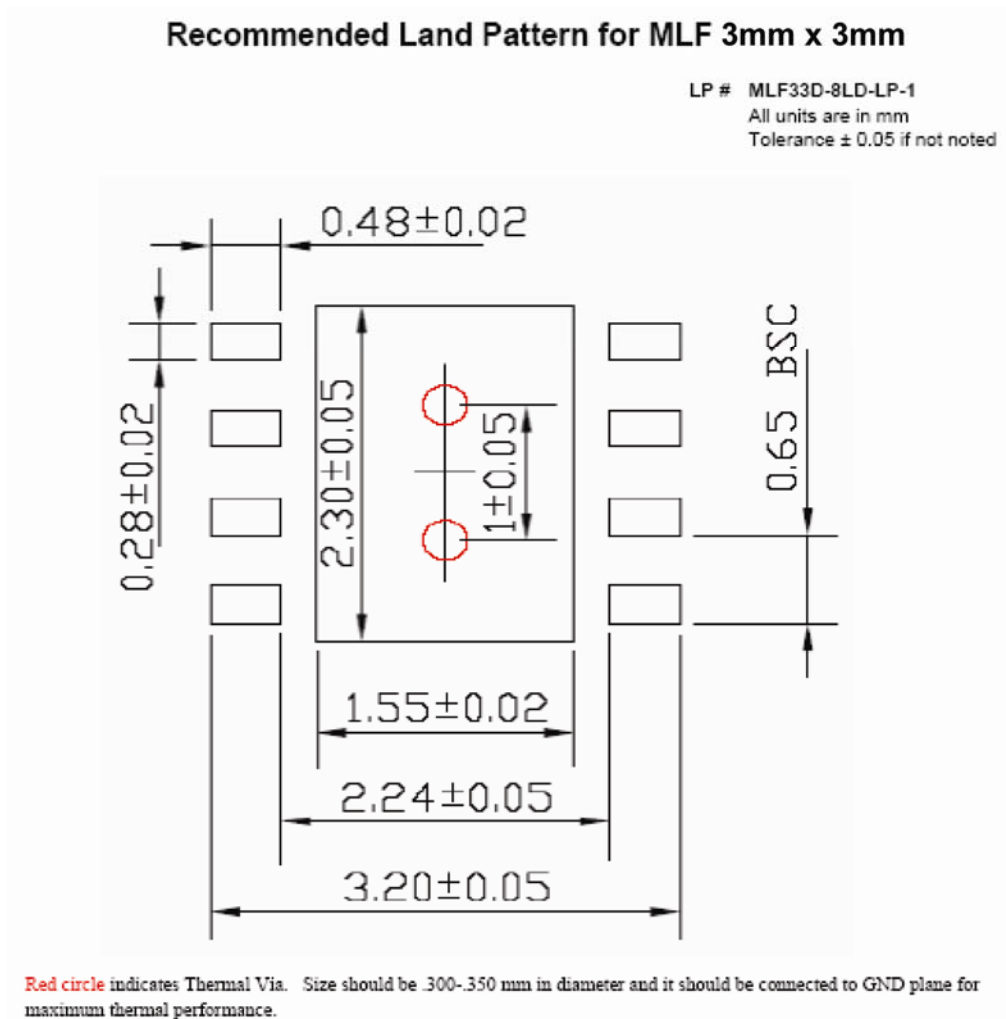
LP # SOICNEP-8LD-LP-1
 All units are in inches
 Tolerance ± 0.05 if not noted



Red circle indicates Thermal Via. Size should be .015-.017 inches in diameter and it should be connected to GND plane for maximum thermal performance.

8-Pin Exposed Pad SOIC

Recommended Land Pattern (Continued)



8-Pin 3mm x 3mm MLF[®]

Red circle indicates Thermal Via. Size should be .300mm – .350mm in diameter, 1.00mm pitch, and it should be connected to GND plane for maximum thermal performance.

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA
TEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB <http://www.micrel.com>

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